



General Description

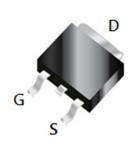
D1MNM020 use advanced SGT MOSFET technology to provide low $R_{DS(ON)}$, low gate charge, fast switching and excellent avalanche characteristics.

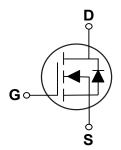
BV _{DSS}	R _{DS(ON)}	Ι _D
100 V	20 mΩ	40 A

Features

- $R_{DS(ON)} \leq 20 m\Omega @V_{GS} = 10V$
- Extremely Low Switching Loss
- Excellent Stability and Uniformity or Invertors

TO-252 Pin Configuration





Applications

- · Consumer Electronic Power Supply
- Motor Control
- · Synchronous-Rectification
- · Isolated DC

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	±20	V
I _D	Drain Current - Continuous (T _C =25°C) (NOTE 1)	40	Α
I _{DM}	Drain Current - Pulsed (T _C =25°C) (NOTE 2)	120	Α
P_D	Power Dissipation (T _C =25°C) (NOTE 3)	72	W
E _{AS}	Single Pulse Avalanche Energy (NOTE 4)	30	mJ
T_J	Operating Junction Temperature Range	-55 to 150	°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
Marking Code		NM020 , APG40N10D	

Thermal Characteristics					
Symbol	Parameter	Value	Unit		
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	62	°C/W		
$R_{\theta JC}$	Thermal Resistance Junction to Case	1.74	°C/W		





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	100			V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =100V , V _{GS} =0V			1	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} =±20V , V_{DS} =0V			±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =8A		1	20	- mΩ
		V _{GS} =4.5V , I _D =6A			26	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_{D}=250uA$	1.0		2.5	V

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Q_g	Total Gate Charge			19.8		
Q_{gs}	Gate-Source Charge	V_{DS} =50V , V_{GS} =10V , I_{D} =8A		2.4		nC
Q_{gd}	Gate-Drain Charge			5.3		
$T_{d(on)}$	Turn-On Delay Time			17.8		
T _r	Rise Time	V_{DS} =50V , V_{GS} =10V , R_{G} =2.2 Ω , I_{D} =10A		3.9		nS
$T_{d(off)}$	Turn-Off Delay Time			33.5		113
T_f	Fall Time			3.2		
C_{iss}	Input Capacitance			1190.6		
C _{oss}	Output Capacitance	V_{DS} =50V , V_{GS} =0V , f=1MHz		194.6		pF
C_{rss}	Reverse Transfer Capacitance			4.1		

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Diode forward current	V _G =V _D =0V,Force Current			40	Α
I _{SM}	Pulsed Source Current				120	Α
V_{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =8A			1.3	V
t _{rr}	Reverse Recovery Time	I _S =8A , di/dt=100A/us		50.2		ns
Q_{rr}	Reverse Recovery Charge			95.1		nC
I _{rrm}	Peak Reverse Recovery Current			2.5		Α

NOTES:

- 1. Calculated continuous current based on maximum allowable junction temperature.
- 2. Repetitive rating: pulse width limited by max. junction temperature.
- 3. Pd is based on max. junction temperature, using junction-case thermal resistance.
- 4. V_{DD} =50 V, R_G =25 Ω , L=0.3 mH, starting T_J =25 $^{\circ}$ C.





Characteristics Curves

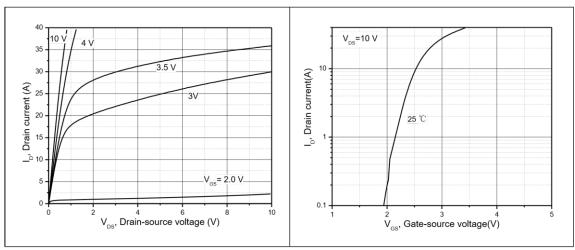


Figure 1, Typ. output characteristics

Figure 2, Typ. transfer characteristics

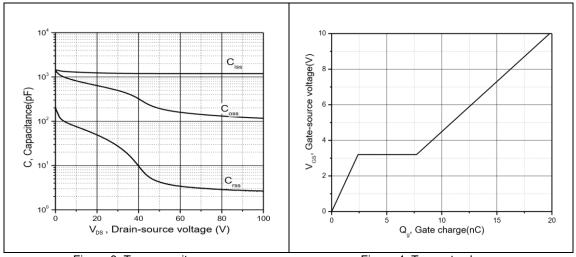


Figure 3, Typ. capacitances

Figure 4, Typ. gate charge

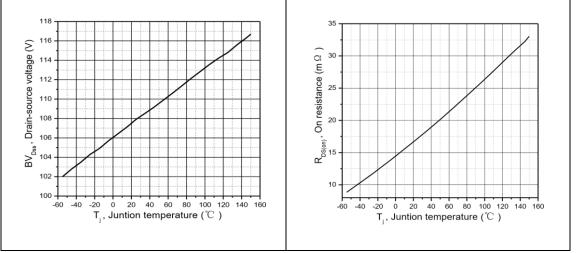


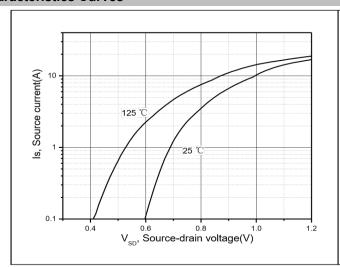
Figure 5, Drain-source breakdown voltage

Figure 6, Drain-source on-state resistance





Characteristics Curves



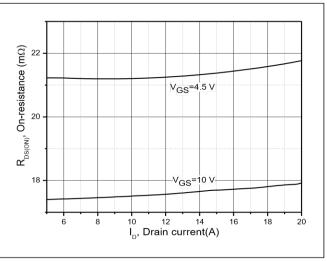


Figure 7, Forward characteristic of body diode

Figure 8, Drain-source on-state resistance

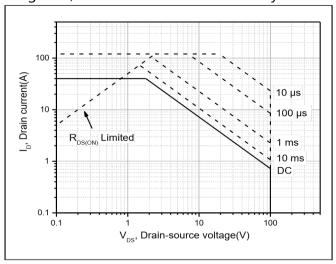
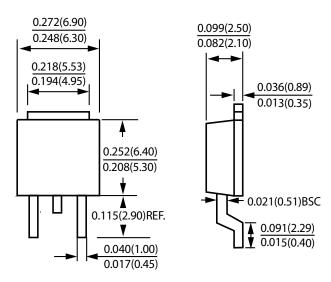


Figure 9, Safe operation area T_C=25 °C

Package Outline Dimensions



TO-252
Dimensions in inches and (millimeters)





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